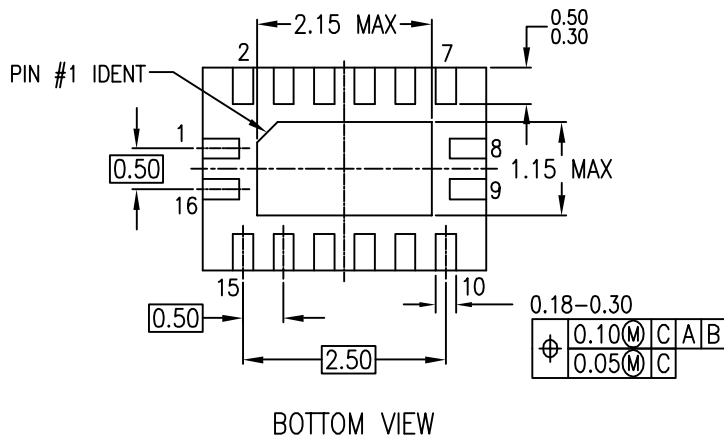
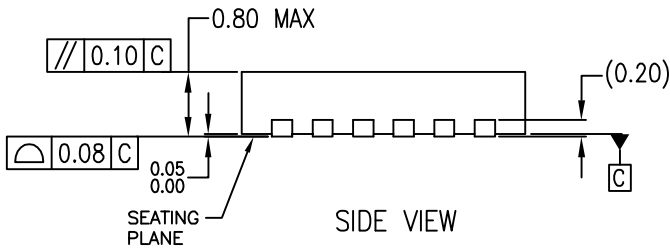
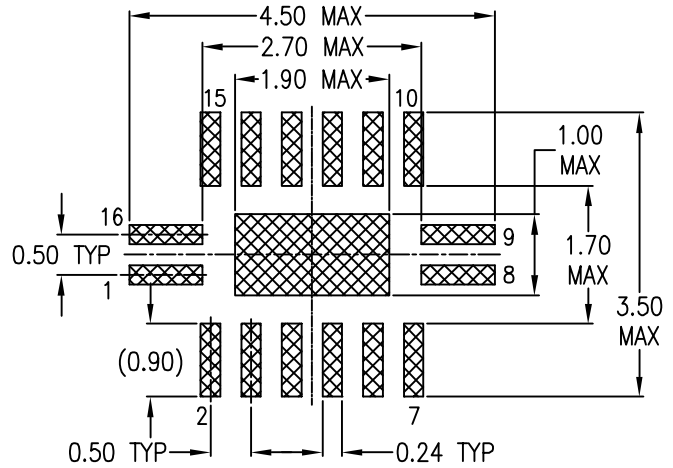
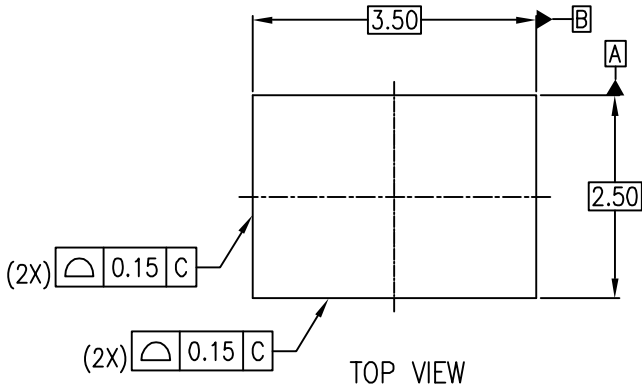


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REVISIONS				
LTR	DESCRIPTION	EDCN	DATE	BY/APP'D
A	RELEASE TO DOCUMENT CONTROL		31-3-2003	FEITAN



NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-241, VARIATION AB
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

MLP16ErevA

APPROVALS	DATE	<b>FAIRCHILD</b> Bayan Lepas, FIZ, SEMICONDUCTOR 11900, Penang, Malaysia.		
DRAWN FEITAN	17-3-2003	16LD, DQFN, JEDEC MO-241, 2.5x3.5 MM PACKAGE		
DFTG. CHK.				
ENGR. CHK.				
		SCALE N/A	SIZE N/A	DRAWING NUMBER MKT-MLP16E
		DO NOT SCALE DRAWING		REV A
				SHEET 1 of 1